

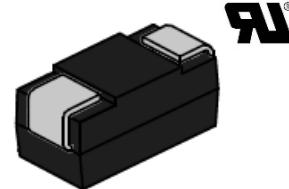


## CP0080TBA TSS

Rev.1.3

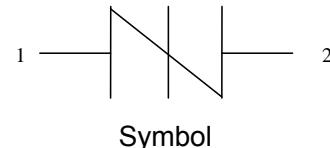
## DESCRIPTION:

CP0080TBA is a type of semiconductor component. It is designed to protect baseband equipment from damaging overvoltage transients.



## FEATURES:

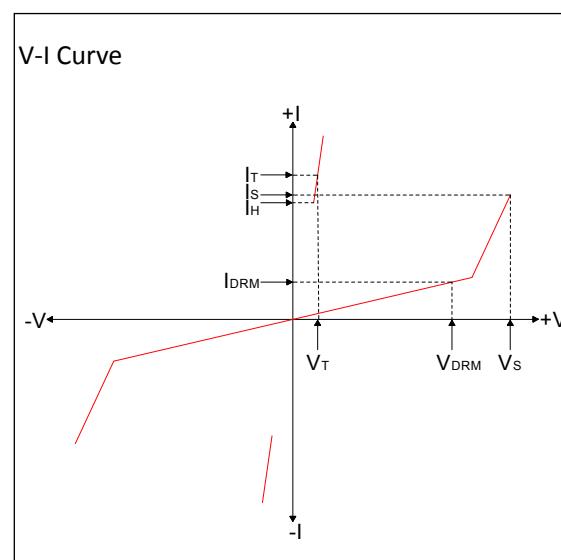
- ✧ Low capacitance.
- ✧ Low profile package.
- ✧ Low on-state voltage.
- ✧ Excellent capability of absorbing transient surge.
- ✧ Quick response to surge voltage (ns Level).
- ✧ Eliminates overvoltage caused by fast rising transients.
- ✧ Moisture sensitivity level: Level 1.
- ✧ Non degenerative.
- ✧ UL 497B item recognized. (File No.: E480698).

ABSOLUTE MAXIMUM RATINGS ( $T_A=25^\circ\text{C}$ , RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Storage temperature range	$T_{STG}$	-60 to +150	$^\circ\text{C}$
Operating junction temperature range	$T_J$	-40 to +125	$^\circ\text{C}$
Repetitive peak pulse current@10/1000 $\mu\text{s}$	$I_{PP}$	80	A

ELECTRICAL CHARACTERISTICS( $T_A=25^\circ\text{C}$ )

Symbol	Parameter
$V_{DRM}$	Peak off-state voltage
$I_{DRM}$	Off-state current
$V_s$	Switching voltage
$I_s$	Switching current
$V_T$	On-state voltage
$I_T$	On-state current
$I_H$	Holding current
$C_O$	Off-state capacitance



**MARKING**

P8BA : Device Marking Code  
1927: the 27th week, 2019

**ELECTRICAL CHARACTERISTICS( $T_A=25^\circ\text{C}$ , continued)**

Part Number	$I_{DRM}@V_{DRM}$		$V_s^{(1)}@I_s$		$V_T@I_T$		$I_H$	$C_o^{(2)}$	Marking
	$\mu\text{A}$	$\text{V}$	$\text{V}$	$\text{mA}$	$\text{V}$	$\text{A}$	$\text{mA}$	$\text{pF}$	
	max	min	max	max	max	max	min	typ	
CP0080TBA	1	6	15	800	4	2.2	10	15	P8BA

(1)  $V_s$  is measured at 100kV/s

(2) Off-state capacitance is measured in  $V_{DC}=2\text{V}$ ,  $V_{RMS}=1\text{V}$ ,  $f=1\text{MHz}$

**SURGE RATINGS**

Series	$I_{PP}(\text{A})\text{min}$			
	2/10μs	8/20μs	10/360μs	10/1000μs
B	250	250	125	80

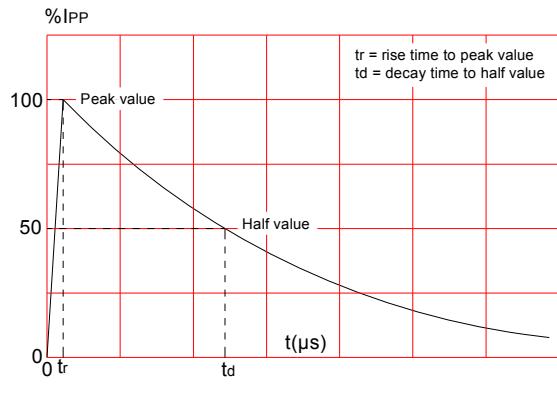
**ORDERING INFORMATION**

<u>CP</u>	<u>008</u>	<u>0</u>	<u>T</u>	<u>B</u>	<u>A</u>
Low cap series SIDAC					Capacitance level
					Surge ratings: 4kV(10/700μs)
	Median voltage				
		0: Bi-direction			Package type

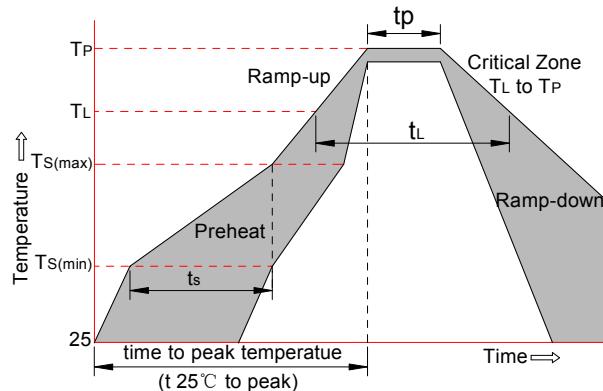
## SOLDERING PARAMETERS

Reflow Condition		Pb-Free assembly (see FIG.2)
Pre Heat	-Temperature Min ( $T_{s(\min)}$ )	+150 °C
	-Temperature Max( $T_{s(\max)}$ )	+200 °C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquidus Temp ( $T_L$ )to peak)		3 °C/sec. Max
$T_{s(\max)}$ to $T_L$ - Ramp-up Rate		3 °C/sec. Max
Reflow	-Temperature( $T_L$ ) (Liquidus)	+217 °C
	-Temperature( $t_L$ )	60-150 secs.
Peak Temp ( $T_p$ )		+260(+0/-5) °C
Time within 5 °C of actual Peak Temp ( $t_p$ )		30 secs. Max
Ramp-down Rate		6 °C/sec. Max
Time 25 °C to Peak Temp ( $T_p$ )		8 min. Max
Do not exceed		+260 °C

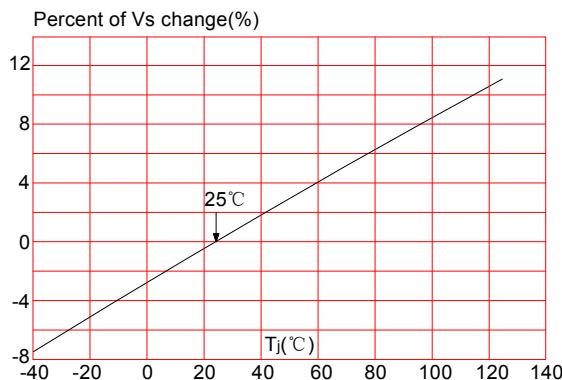
**FIG.1:**  $tr \times td$  pulse waveform



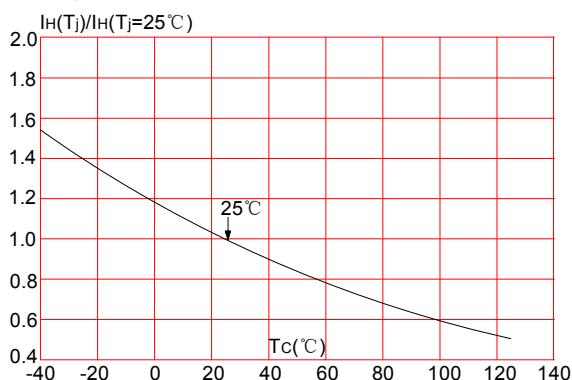
**FIG.2:** Reflow condition



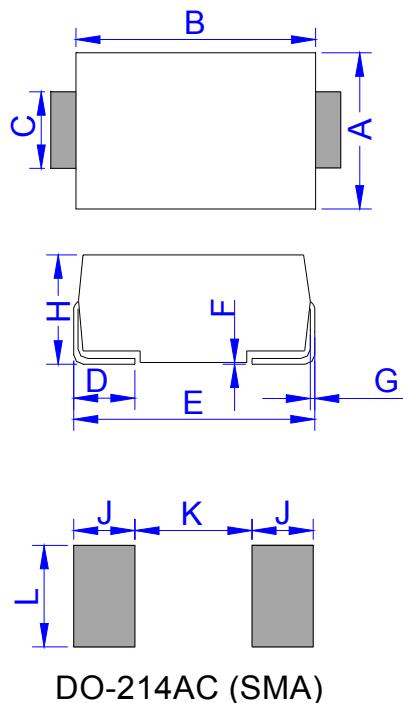
**FIG.3:** Normalized Vs change vs. junction temperature



**FIG.4:** Normalized DC holding current vs. case temperature

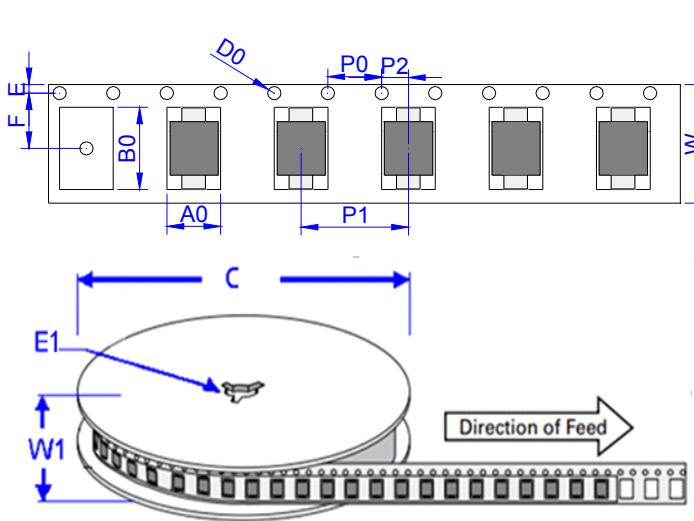


## PACKAGE MECHANICAL DATA



Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.60	3.00	0.102	0.118
B	4.15	4.65	0.163	0.183
C	1.25	1.65	0.049	0.065
D	0.95	1.52	0.037	0.060
E	4.90	5.30	0.193	0.209
F	0.051	0.203	0.002	0.008
G	0.15	0.31	0.006	0.012
H	2.00	2.44	0.079	0.096
J	2.00		0.079	
K		2.30		0.091
L	1.80		0.071	

## TAPE AND REEL SPECIFICATION-SMA



Ref.	Dimensions	
	Millimeters	Inches
A0	2.79 ± 0.3	0.110 ± 0.012
B0	5.33 ± 0.3	0.210 ± 0.012
C	330.0	13.0
D0	1.55 ± 0.1	0.061 ± 0.004
E	1.75 ± 0.2	0.069 ± 0.008
E1	13.3 ± 0.3	0.524 ± 0.012
F	5.5 ± 0.2	0.217 ± 0.008
P0	4.00 ± 0.2	0.157 ± 0.008
P1	4.00 ± 0.2	0.157 ± 0.008
P2	2.00 ± 0.2	0.079 ± 0.008
W	12.0 ± 0.2	0.472 ± 0.008
W1	15.7 ± 2.0	0.618 ± 0.079

PART No.	UNIT WEIGHT (g/PCS) typ.	REEL (PCS)	PER CARTON (PCS)	DESCRIPTION
CP0080TBA	0.066	7,500	120,000	13 inch reel pack



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